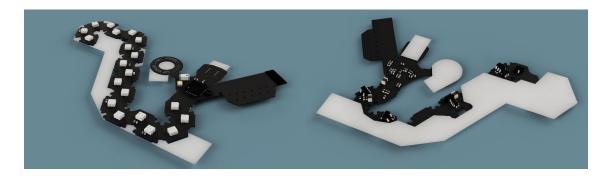
D20v11



<u>PCB Type</u>: Flexible PCB <u>Board type</u>: Single pieces

Layer: 2 Layers

Material: Polyimide Flex: FPC Thickness: 0.13 mm

Solder Mask (Coverlay): Black Coverlay

Silkscreen: White Gold fingers: No

Stiffener: BOTTOM PI: 0.15 mm

Outline filename: *Main-B_Stiffener.gbr*<u>Surface Finish:</u> Immersion gold (ENIG) (1U")

<u>Finished Copper:</u> 0.5 oz **Annealed** Cu (18µm)

E-test: 100%

3M/Tesa tape: TOP

Glue Outline filename: Main-F_ Glue.gbr

Backing Tape Outline filename: Main-F_Tape.gbr

SMT: TOP + BOT